



ERM8



01

PLATING

OPTION

D

10 μ" (0.25 μm)

Gold on contact

Matte Tin on tail

.220

.

(2.10)

.082

-EGPS

(0.80) .031

RA

ERM8-060-01-L-D-EM2-TR

OTHER

OPTION

-K

(6.00 mm) .236'

DIA Polyimide

Film Pick

& Place Pad

—L

(-010, -020, -025,

–DSS

Post Shield

(Hot Swap)

-025 pos. only)

Differential Pair Extended Guide

-030 pos.only)

TR

TR

= Tape &

Reel

ERM8-RA, ERM8-EM SERIES

(0.80 mm) .0315"

EDGE RATE[®] STRIPS H I I

NO. OF POSITIONS

PER ROW

<u>-010, -013, -020, </u>

-025, -030, -040, -049,

-050, -060, -070, -075

No. of Positions x

(0.80) .0315 + (13.00) .512

ERM8-RA / ERM8-EM **Board Mates:** FRF8

ERM8-RA Cable Mates:

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?ERM8-RA or www.samtec.com?ERM8-EM

Insulator Material: Black LCP Terminal Material: Phosphor Bronze Latch Material: BeCu Plating: Au or Sn over 50 μ" (1.27 μm) Ni Current Rating: 2.2 A per pin (2 pins powered) **Operating Temp Range:** -55 °C to +125 °C Voltage Rating: 235 VAC / 318 VDC RoHS Compliant: Yes

PROCESSING

Lead-Free Solderable: Yes SMT Lead Coplanarity (ERM8-RA): (0.10 mm) .004" max (010-050) (0.15 mm) .006" max (060-075) SMT Lead Coplanarity (ERM8-EM): (0.10 mm) .004" max (005-030) (0.12 mm) .005" max (040-075)

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



ALSO AVAILABLE (MOQ Required)

Other Positions

- Solder leads & weld tab for ٠ (2.36 mm) .093" thick board
- · Other platings

Contact Samtec.

STANDARD

POWER.org

ARM/HSSTP

POWER.org

Notes:

Patented





Some lengths, styles and options are non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice WWW.SAMTEC.COM

-L OPTION

All parts within this catalog are built to Samtec's specifications. Customer specific requirements must be approved by Samtec and identified in a Samtec customer-specific drawing to apply.